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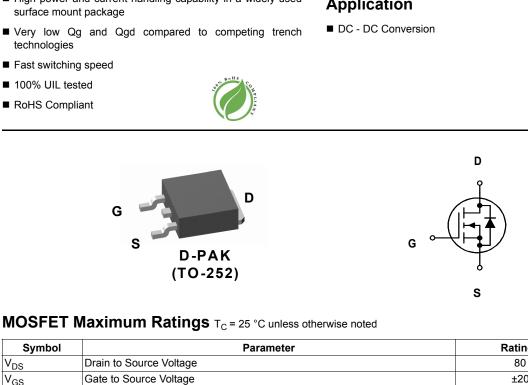


## **ON Semiconductor**®

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### N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET **80 V, 37 A, 23 m**Ω

#### **Features**

FAIRCHILD

FDD86326

- Shielded Gate MOSFET Technology
- Max r<sub>DS(on)</sub> = 23 mΩ at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 8 A
- Max r<sub>DS(on)</sub> = 37 mΩ at V<sub>GS</sub> = 6 V, I<sub>D</sub> = 4.6 A
- High performance trench technology for extremely low r<sub>DS(on)</sub>
- High power and current handling capability in a widely used

#### **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> process that incorporates Shielded Gate technology. This process has been optimized for r<sub>DS(on)</sub>, switching performance and ruggedness.

#### Application



Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			80	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous	T <sub>C</sub> = 25 °C		37		
	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	8	А	
	-Pulsed			40		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	121	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C	T <sub>C</sub> = 25 °C		W	
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	3.1	vv	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

#### **Thermal Characteristics**

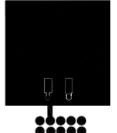
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	2.0	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient (Note 1	a) 40	C/VV

#### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD86326	FDD86326	D-PAK(TO-252)	13 "	16 mm	2500 units

March 2015

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	80			V
$\Delta BV_{DSS}$ $\Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		67		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 64 V, V <sub>GS</sub> = 0 V			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS}$ = ±20 V, $V_{DS}$ = 0 V			±100	nA
On Chara	cteristics (Note 2)					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA	2	3.1	4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-8.5		mV/°C
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 8 A		19 23		
		V <sub>GS</sub> = 6 V, I <sub>D</sub> = 4.6 A		26	37	mΩ
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 8 A, T <sub>J</sub> = 125 °C		33	44	
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 8 A		21		S
-	Characteristics					1
C <sub>iss</sub>	Input Capacitance	– V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V,		780	1035	pF
C <sub>oss</sub>	Output Capacitance	$v_{DS} = 50 v_{1}, v_{GS} = 0 v_{1}$ = f = 1 MHz		180	240	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			15	25	pF
R <sub>g</sub>	Gate Resistance			0.4		Ω
Switching	g Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time			7.6	15	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 50 V, I <sub>D</sub> = 8 A,		3.0	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$		13.4	24	ns
t <sub>f</sub>	Fall Time	-		2.9	10	ns
Qg	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		13.4	19	nC
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V V_{DD} = 50 V,$		7.6	11	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	I <sub>D</sub> = 8 A		4.0		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			3.7		nC
Drain-Sou	urce Diode Characteristics					
V <sub>SD</sub>	Source to Drain Diode, Ecoward Voltage	$V_{GS} = 0 V, I_S = 8 A$ (Note 2)		0.8	1.3	v
	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2.6 A$ (Note 2)		0.7	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 8 A, di/dt = 100 A/μs		43	68	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$F = 0 \Lambda, u/u = 100 \Lambda/\mu S$		43	68	nC



2. Pulse Test: Pulse Width < 300  $\mu s,$  Duty cycle < 2.0%.

a. 40 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.

2

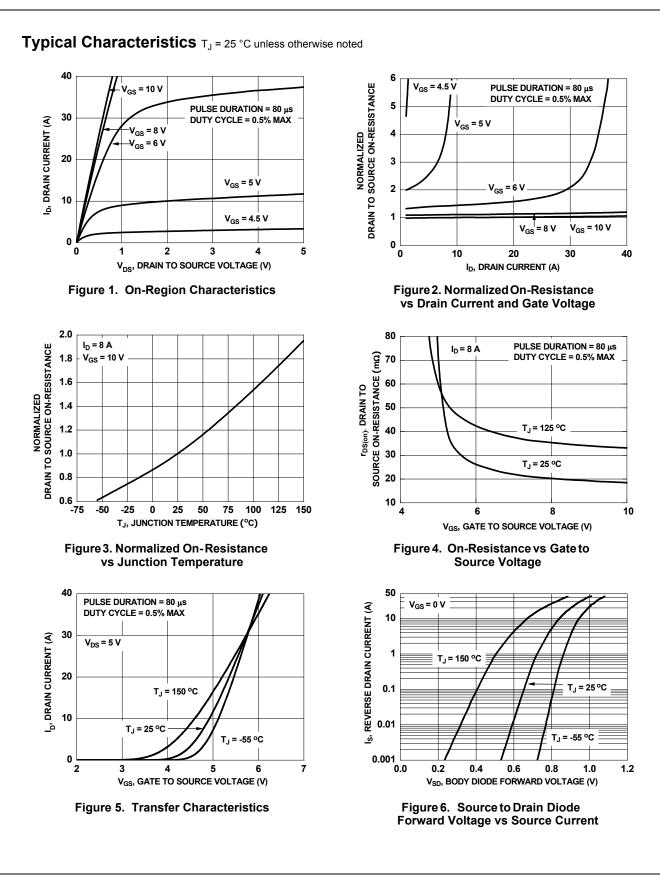


b. 96 °C/W when mounted on a minimum pad of 2 oz copper.

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3. Starting T<sub>J</sub> = 25°C, L = 3 mH, I<sub>AS</sub> = 9 A, V<sub>DD</sub> = 80 V, V<sub>GS</sub> = 10 V.

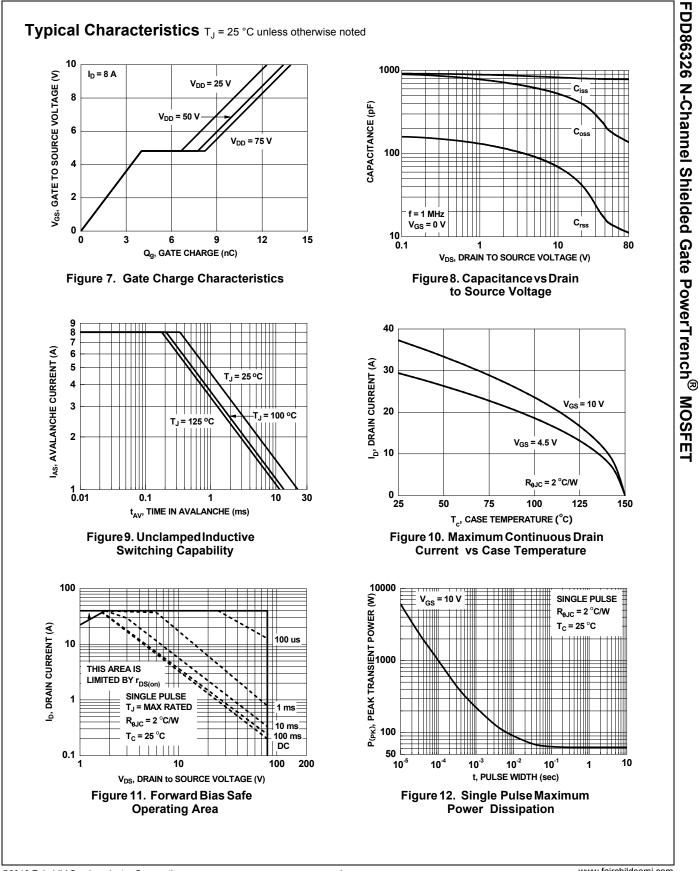
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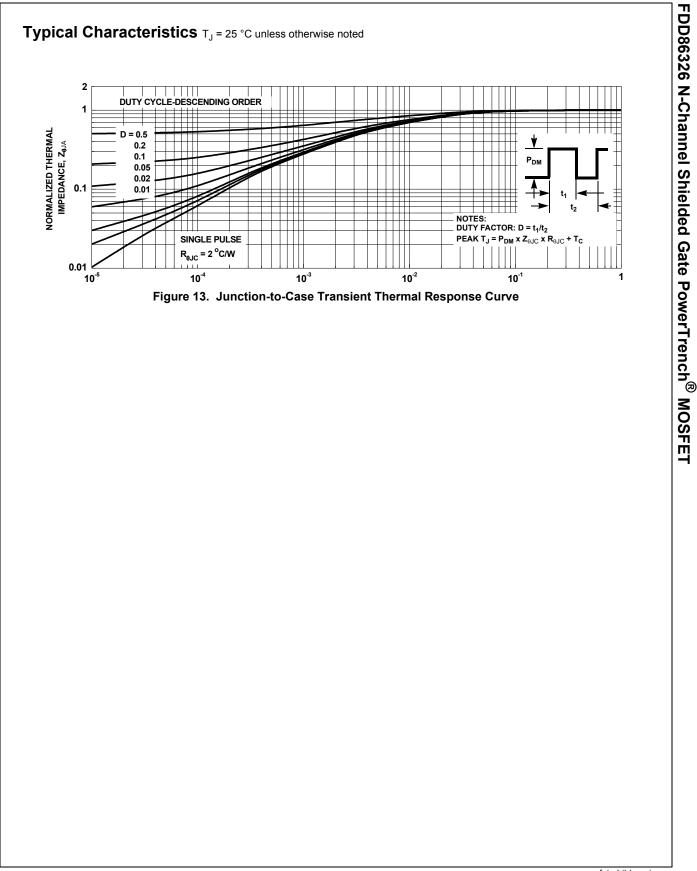
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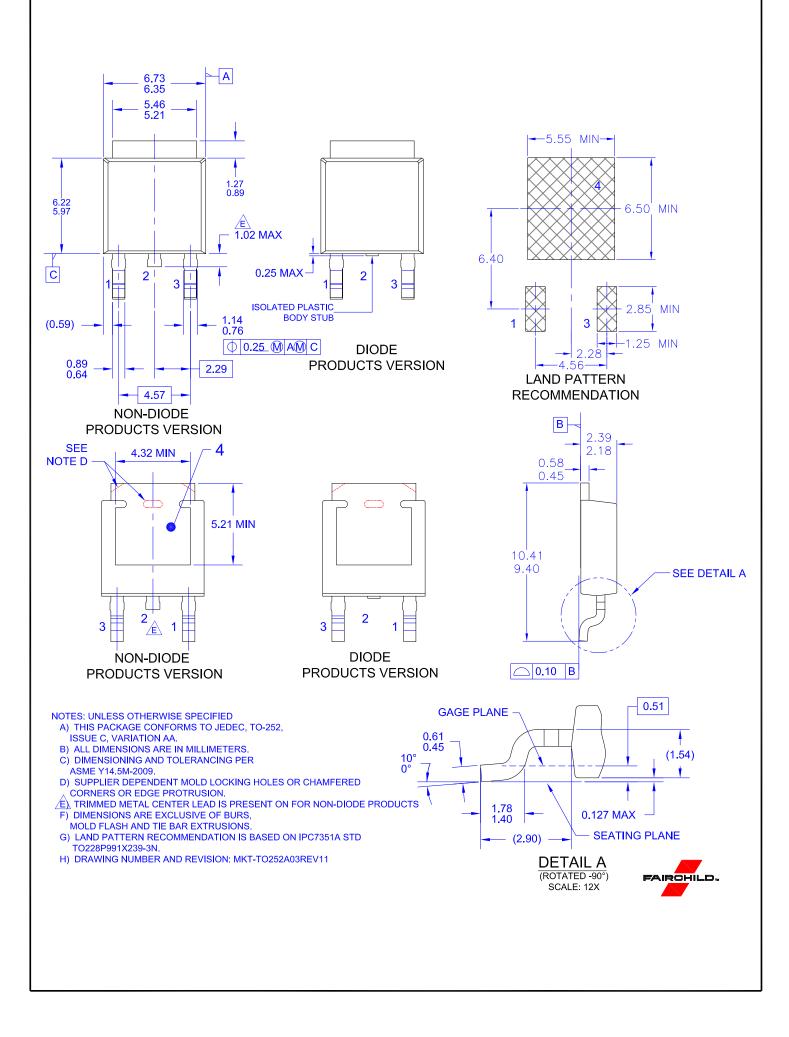
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